# **GBJ80X SERIES**

## **GLASS PASSIVATED SINGLE-PHASE BRIDGE RECTIFIER**

产

品

规

确

格

认

书

### GBJ8005 THRU GBJ810

### GLASS PASSIVATED SINGLE-PHASE BRIDGE RECTIFIER





REVERSE VOLTAGE: FORWARD CURRENT:

**50 to 1000 VOLTS 8.0 AMPERE** 

### **FEATURES**

· Glass passivated chip junction

· Reliable low cost construction utilizing molded plastic technique

· Ideal for printed circuit board

· Low forward voltage drop

· Low reverse leakage current

· High surge current capability

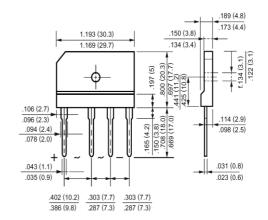
### **MECHANICAL DATA**

Case: Molded plastic, GBJ

Epoxy: UL 94V-O rate flame retardant

Terminals: Leads solderable per MIL-STD-202,

method 208 guaranteed Mounting position: Any Weight: 0.23ounce, 6.6gram GBJ



**Dimensions in inches and (millimeters)** 

### Maximum Ratings and Electrical Characteristics

Ratings at 25 ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

	Symbols	GBJ8005	GBJ801	GBJ802	GBJ804	GBJ806	GBJ808	GBJ810	Units
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current with Heatsink at $T_C$ =110	I <sub>(AV)</sub>	8.0							Amp
Peak Forward Surge Current, 8.3ms single half-sine-wave superimposed on rated load (JEDEC method)	I <sub>FSM</sub>	170							Amp
Maximum Forward Voltage Drop per Element at 4.0A DC and 25	$V_{\mathrm{F}}$	1.0							Volts
Maximum Reverse Current at $T_A$ =25 at Rated DC Blocking Voltage $T_A$ =125	$I_R$	5.0 500							uAmp
Typical Junction Capacitance (Note 1)	$C_{J}$	55							pF
Typical Thermal Resistance (Note 2)	$R_{\theta JC}$	1.6							<b>/W</b>
Operating and Storage Temperature Range	T <sub>J</sub> , Tstg	-55 to +150							

#### **NOTES:**

- 1- Measured at 1 MHz and applied reverse voltage of 4.0 VDC.
- 2- Thermal Resistance from Junction to Case with Device Mounted on 75mm x 75mm x 1.6mmCu Plate Heatsink.





### RATINGS AND CHARACTERISTIC CURVES

